# SN -30W Series

# 30W 2:1 Regulated Single & Dual output

## **Features**

- Ultra Wide 2:1 Input Range
- 1600 VDC Isolation
- No Minimum Load Required
- Efficiency up to 92%
- Extended Operating Temperature Range -40 ~ 100°C max.
- Adjustable Output Voltage
- Remote On/Off Control (CTRL)
- Continuous Short Circuit Protection
- Over Current Protection
- Over Voltage Protection

**OUTPUT SPECIFICATIONS** 

- Over Temperature Protection
- Soft Start



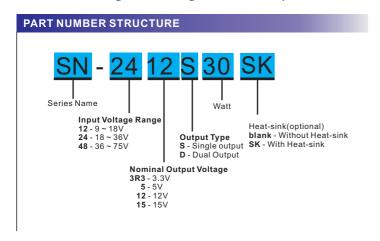
The SN series is a family of cost effective 30W single & dual output DC-DC converters. These converters combine copper package in a 1"x1" case with high performance features, continuous short circuit protection with automatic restart and tight line / load regulation. Devices are encapsulated using flame retardant resin. Input voltages of 12,24 and 48 with output voltage of 3.3, 5, 12, 15,  $\pm 12$ ,  $\pm 15$ Vdc. High performance features include high efficiency operation up to 92% and output voltage accuracy of  $\pm 1\%$  maximum.

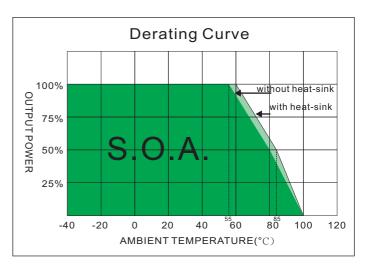
ALL SPECIFICATIONS ARE TYPICAL AT 25°C, NOMINAL INPUT AND FULL LOAD UNLESS OTHERWISE NOTED.

v(Trim)	Single output: ±10%, max.	
utput Voltage Accuracy utput Voltage Adjustability(Trim)		
Maximum Output Current		
	±0.5%, max.	
100%)	Single: ±0.5%, max.	
	Dual:±1%, max.(balanced load)	
ıtput) (1)	±5%	
vidth		
	Single output:75mVpk-pk,max.	
C for each outp	ut dual output:60mVpk-pk,max.	
3V output	3.9V	
5V output	6.2V	
2V output	15V	
	18V	
	±15V	
5V output	±18V	
	150% of FL, typ.	
	Indefinite(hiccup)	
	(Automatic Recovery)	
	±0.02%/°C	
	See table	
	250us, typ.	
tion(3)	±3%, max.	
	Single Output 3.3V:±5%,max.	
NS		
	See table	
dule ON / OFF	8.6Vdc / 7.9Vdc, typ.	
dule ON / OFF	17.8Vdc / 16.5Vdc, typ.	
dule ON / OFF	34Vdc / 32.5Vdc, typ.	
	30mS, typ.	
t resistive load)		
	Pi Type	
	See table, max.	
	See table, typ.	
rrent(4)	30mAp-p, typ.	
ogic)(5)		
	3.0 12Vdc or open circuit	
0 1.2Vdd	or Short circuit pin2 and pin 3	
	2 mA, typ.	
	vidth C C for each output .3V output .5V output .2V output .5V out	

<b>GENERAL SPECIFICATIONS</b>		
Efficiency		See table, typ.
I/O Isolation Voltage(60sec)		-
Input/Output		1600Vdc
Case/Input & Output		1600Vdc
Isolation Resistance		1000 MΩ, min.
Isolation Capacitance		2000 pF, max.
Switching Frequency		
	out Models	270kHz, typ.
	other Models	330kHz, typ. 95% rel H
Humidity		>370 Khrs
Reliability Calculated MTBF(MIL-HDBI		50-1 , 62368-1
Safety Standard		50-1, 62368-1
Safety Approvals		50-1, 62368-1
Calcty Approvals		50-1,62368-1
ABSOLUTE SPECIFICATION		00 1,02000 1
These are stress ratings. Exposure		hese
conditions may adversely affect long		1000
Input Surge Voltage(100mS)	,	
12 Models		25 Vdc, max.
24 Models		50 Vdc, max.
48 Models		100 Vdc, max.
Soldering Temperature(1.5mm from cas		260°C , max.
PHYSICAL SPECIFICATIONS	3	
Case Material		Copper
	ductive Black Plastic(	UL94V-0 rated)
Base Material Non-con-	Ф1.0mm Brass	UL94V-0 rated) s Solder-coated
Base Material Non-cond Pin Material Potting Material	Ф1.0mm Brass	UL94V-0 rated) s Solder-coated UL94V-0 rated)
Base Material Non-condition Material Potting Material Weight	Ф1.0mm Brass Ероху (	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g
Base Material Non-condition Pin Material Potting Material Weight Dimensions	Φ1.0mm Brass Epoxy (	UL94V-0 rated) s Solder-coated UL94V-0 rated)
Base Material Non-condition Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC	Φ1.0mm Brass Epoxy ( 1.0 ATIONS	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41"
Base Material Non-condition Pin Material Potting Material Weight Dimensions	Φ1.0mm Brass Epoxy (  1.0  ATIONS -40°C ~ +100°C(	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41"
Base Material Non-condition Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature	Φ1.0mm Brass Epoxy (  1.0  ATIONS -40°C ~ +100°C(	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load)
Base Material Non-condition Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(  -40°C ~ +55	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C
Base Material Non-condition Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(  -40°C ~ +55  Without Heat-sink	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min.
Base Material Non-condition Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(  -40°C ~ +55  Without Heat-sink With Heat-sink	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min.
Base Material Non-condition Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance Storage Temperature	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(  -40°C ~ +55  Without Heat-sink With Heat-sink	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min. 55°C ~ +125°C
Base Material Non-condition Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance Storage Temperature Over Temperature Protection ( Case	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(  -40°C ~ +55  Without Heat-sink With Heat-sink	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min. 55°C ~ +125°C 115°C, typ.
Base Material Non-condition Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance Storage Temperature Over Temperature Protection ( Case Cooling(7)	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(  -40°C ~ +55  Without Heat-sink With Heat-sink	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min. 55°C ~ +125°C
Base Material Non-content Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance Storage Temperature Over Temperature Protection ( Case Cooling(7)	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(-40°C ~ +55)  Without Heat-sink With Heat-sink	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min. 55°C ~ +125°C 115°C, typ. ure Convection
Base Material Non-content Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance Storage Temperature Over Temperature Protection ( Case Cooling(7) EMC CHARACTERISTICS Radiated Emissions	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(-40°C ~ +55)  Without Heat-sink With Heat-sink e )  Nat	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min. 55°C ~ +125°C 115°C, typ. ture Convection
Base Material Non-content Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance Storage Temperature Over Temperature Protection ( Case Cooling(7) EMC CHARACTERISTICS Radiated Emissions Conducted Emissions(8)	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(  -40°C ~ +55  Without Heat-sink With Heat-sink  -  e )  Nat  EN55032  EN55032	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min. 55°C ~ +125°C 115°C, typ. ture Convection  CLASS A CLASS A
Base Material Non-condition Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance Storage Temperature Over Temperature Protection ( Case Cooling(7) EMC CHARACTERISTICS Radiated Emissions Conducted Emissions(8) ESD	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(  -40°C ~ +55  Without Heat-sink With Heat-sink   E N55032 EN55032 IEC61000-4-2	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min. 55°C ~ +125°C 115°C, typ. ture Convection  CLASS A CLASS A Perf. Criteria A
Base Material Non-condition Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance Storage Temperature Over Temperature Protection ( Case Cooling(7) EMC CHARACTERISTICS Radiated Emissions Conducted Emissions(8) ESD RS	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(  -40°C ~ +58  Without Heat-sink With Heat-sink   EN55032 EN55032 EN55032 IEC61000-4-2 IEC61000-4-3	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min. 55°C ~ +125°C 115°C, typ. ture Convection  CLASS A CLASS A Perf. Criteria A
Base Material Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance Storage Temperature Protection ( Case Cooling(7) EMC CHARACTERISTICS Radiated Emissions Conducted Emissions(8) ESD RS EFT(9)	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(  -40°C ~ +55  Without Heat-sink With Heat-sink  e )  Nat  EN55032 EN55032 EN55032 IEC61000-4-2 IEC61000-4-3 IEC61000-4-4	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min. 55°C ~ +125°C 115°C, typ. cure Convection  CLASS A CLASS A Perf. Criteria A Perf. Criteria A
Base Material Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance Storage Temperature Protection ( Case Cooling(7) EMC CHARACTERISTICS Radiated Emissions Conducted Emissions(8) ESD RS EFT(9) Surge (9)	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C( -40°C ~ +55  Without Heat-sink With Heat-sink e )  Nat  EN55032 EN55032 EN55032 IEC61000-4-2 IEC61000-4-3 IEC61000-4-4 IEC61000-4-5	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41"  See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min. 55°C ~ +125°C 115°C, typ. ture Convection  CLASS A Perf. Criteria A Perf. Criteria A Perf. Criteria A
Base Material Non-content Pin Material Potting Material Weight Dimensions ENVIRONMENTAL SPECIFIC Operating Ambient Temperature Maximum Case Temperature Thermal Impedance Storage Temperature Protection ( Case Cooling(7) EMC CHARACTERISTICS Radiated Emissions Conducted Emissions(8) ESD RS EFT(9)	Φ1.0mm Brass Epoxy (  1.0  ATIONS  -40°C ~ +100°C(  -40°C ~ +55  Without Heat-sink With Heat-sink  e )  Nat  EN55032 EN55032 EN55032 IEC61000-4-2 IEC61000-4-3 IEC61000-4-4	UL94V-0 rated) s Solder-coated UL94V-0 rated) 19.0g 00"x1.00"x0.41" See Derating Curve) 5°C(For 100% load) 105°C 13°C/W, min. 12°C/W, min. 55°C ~ +125°C 115°C, typ. cure Convection  CLASS A CLASS A Perf. Criteria A Perf. Criteria A

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## MODEL SELECTION GUIDE

	INPUT	INPUT	Current	ОՄРИТ	OUTPU	Γ Current	EFFICIENCY	Capacitor
MODEL NUMBER	Voltage Range	No-Load	Full Load	Voltage	Min.load	Full load	@FL	Load @FL
	(Vdc)	(mA, max.)	(mA, typ.)	(Vdc)	(mA)	(mA)	(%, typ.)	(µF, max.)
SN-123R3S30	9-18, 12V Nominal	10	22 12.64	3.3	0	7000	87	10000
SN-1205S30	9-18, 12V Nominal	10	28 08. 99	5	0	6000	89	7200
SN-1212S30	9-18, 12V Nominal	12	28 08. 99	12	0	2500	89	1200
SN-1215S30	9-18, 12V Nominal	12	2777.78	15	0	2000	90	1000
SN-243R3S30	18-36, 24V Nominal	10	1106.32	3.3	0	7000	87	10000
SN-2405S30	18-36, 24 V Nominal	10	1388.89	5	0	6000	90	7200
SN-2412S30	18-36, 24 V Nominal	10	1388.89	12	0	2500	90	1200
SN-2415S30	18-36, 24 V Nominal	10	1373.63	15	0	2000	91	1000
SN-483R3S30	36-75, 48V Nominal	8	540.73	3.3	0	7000	89	10000
SN-4805S30	36-75, 48V Nominal	8	686.81	5	0	6000	91	7200
SN-4812S30	36-75, 48V Nominal	8	686.81	12	0	2500	91	1200
SN-4815S30	36-75, 48 V Nominal	8	679.35	15	0	2000	92	1000
SN-1212D30	9-18, 12V Nominal	12	28 08. 99	±12	0	±1250	89	±750
SN-1215D30	9-18, 12V Nominal	14	2777.78	±15	0	±1000	90	±500
SN-2412D30	18-36, 24 V Nominal	10	1388.89	±12	0	±1250	90	±750
SN-2415D30	18-36, 24 V Nominal	10	1373.63	±15	0	±1000	91	±500
SN-4812D30	36-75, 48V Nominal	8	686.81	±12	0	±1250	91	±750
SN-4815D30	36-75, 48V Nominal	8	679.35	±15	0	±1000	92	±500

#### NOTE

- 1. One load is 25% to 100% load, the other load is 100% load, the output voltage variable rate is within ±5%.
- 2. Tested by minimal Vin and constant resistive load.
- 3. Tested by normal Vin and 25% load step change (75%-50%-25% of lo).
- 4. Measured Input reflected ripple current with a simulated source inductance of 12uH and a source capacitor Cin(47uF, ESR<1.0Ω at 100KHz).
- 5. The remote on/off control pin is referenced to -Vin(pin2).
- 6. Exceeding the absolute ratings of the unit could cause damage.

It is not allowed for continuous operating.

- 7. "Nature Convection" is usually about 30-65 LFM but is not equal to still air (0 LFM).
- 8. Input filter components are used to help meet conducted emissions,

Which application refer to the EMI Filter of design & feature configuration.

9. An external filter is required if the module has to meet IEC61000-4-4,IEC61000-4-5.

 $The \ SN-12XXXX30 \ recommended \ two \ aluminum \ electrolytic \ capacitor \ (\ Nippon \ chemi-con \ KY \ series, \ 330uF/100V),$ 

two aluminum electrolytic capacitor ( Nippon chemi-con KY series, 470uF/100V) and two inductance of 1.0uH.

The SN-24XXXX30 recommended an aluminum electrolytic capacitor (Nippon chemi-con KY series, 330uF/100V) and a TVS (SMDJ58A,58V,3000Watt peak pulse power) to connect in parallel.

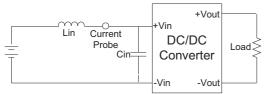
The SN-48XXXX30 recommended an aluminum electrolytic capacitor (Nippon chemi-con KY series, 330uF/100V) and a TVS (SMDJ120A,120V,3000Watt peak pulse power) to connect in parallel.

Which application refer to the EFT/Surge Filter of design & feature configuration.

#### **TEST CONFIGURATIONS**

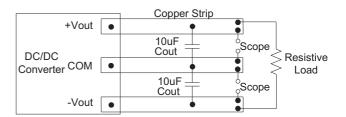
## **Input Reflected Ripple Current Test Step**

Input reflected ripple current is measured through a source inductor Lin(12uH) and a source capacitor Cin(47uF, ESR<1.0 $\Omega$  at 100KHz) at nominal input and full load.



## **Output Ripple & Noise Measurement Test**

To reduce ripple and noise, it is recommended to use a 10uF ceramic disk capacitor to at the output.



#### **DESIGN & FEATURE CONFIGURATIONS**

# **Over Voltage Protection**

The module includes an internal output over voltage protection circuit, which monitors the voltage on the output terminals. If this voltage exceeds the over voltage set point, the module will activate the control loop of internal circuit to clamp the output voltage.

## **Over Temperature Protection**

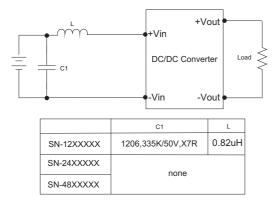
The over temperature protection consists of circuitry that provides protection from thermal damage. If the temperature exceeds the over temperature threshold the module will shut down.

The module will try to restart after shut down, If the over temperature condition still exists during restart, the module will shut down again. This restart trial will continue until the temperature is within specification.

#### **EMI Filter**

Input filter components (C1,L) are used to help meet conducted emissions .

These components should be mounted as close as possible to the module; and all leads should be minimized to decrease radiated noise.



## **Over Current Protection**

The module includes an internal over current protection circuit, which will endure current limiting for an unlimited duration during output over load condition. If the output current exceeds the OCP set point, the module will shut down automatically (hiccup).

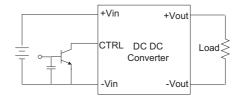
The module will try to restart after shut down. If the over load condition still exists, the module will shut down again.

## CTRL Module ON / OFF

Positive logic turns on the module during high logic and off during low logic.

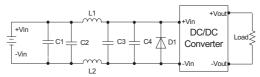
Ctrl module on/off can be controlled by an external switch between the ctrl terminal and -Vin terminal. The switch can be an open collector or open drain

For positive logic if the ctrl feature is not used, please leave the ctrl pin floating.



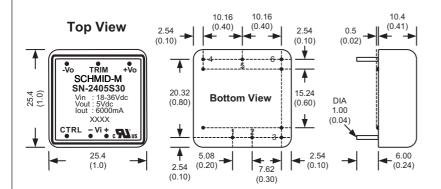
## **EFT/Surge Filter**

Input filter components (C1,C2,C3,C4,L1,L2,D1) are used to help meet IEC61000-4-4 and IEC61000-4-5 .



	C1	C2	L1 · L2	C3	C4	D1
SN-12XXXXX	330uF,100V	470uF,100V	1uH	330uF,100V	470uF,100V	none
SN-24XXXXX	330uF,100V	none	short	none	none	TVS,58V,3kW
SN-48XXXXX	330uF,100V	none	short	none	none	TVS,120V,3kW

## **MECHANICAL SPECIFICATIONS**

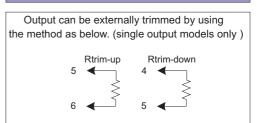


All dimensions are typical in millimeters (inches).

- 1. Pin diameter: 1.0 ±0.05 ( 0.04 ±0.002 )
- 2. Pin pitch tolerance: ±0.35 (±0.014)
- 3. Case Tolerance: ±0.5 (±0.02)
- 4. Stand-off tolerance: ±0.1 (±0.004)

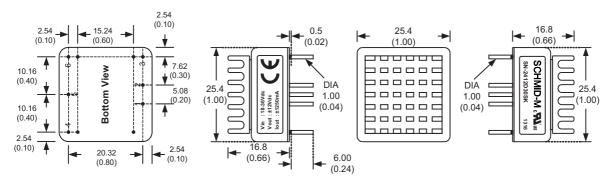
PIN CONNECTIONS				
PIN NUMBER	SINGLE	DUAL		
1	+Vin	+Vin		
2	-Vin	-Vin		
3	CTRL	CTRL		
4	+Vout	+Vout		
5	Trim	Com		
6	-Vout	-Vout		

## **EXTERNAL OUTPUT TRIMMING**



#### **MECHANICAL SPECIFICATIONS**

# With Heat-sink



Order code: SN-XXXXX30SK(contain: heat-sink, thermal pad)

Material: Aluminum

Finish: Anodic treatment (black)

Weight: 2.9 g (0.1oz) (without converter)

Note:

1. Converters will be supplied with heat-sinks already mounted. Please contact factory for quotation.